ART FILM - drill

SURFACE - AIR 0 MM
L1: TOP CONDUCTOR - COPPER 0.035 MM
DIELECTRIC - FR-4 0.175 MM
L2: L2 CONDUCTOR - COPPER 0.018 MM
DIELECTRIC - FR-4 1.14 MM
DIELECTRIC - FR-4 0.175 MM
L3: L3 CONDUCTOR - COPPER 0.018 MM
DIELECTRIC - FR-4 0.175 MM
L4: BOTTOM CONDUCTOR - COPPER 0.035 MM
SURFACE - AIR 0 MM

TOTAL THICKNESS 1.596 MM
ART FILM - assembly_bot_mirror
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